700MHz, Low JITTER, CRYSTAL-TO-3.3V DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

GENERAL DESCRIPTION



The ICS84329B is a general purpose, single output high frequency synthesizer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The VCO operates at a frequency range of 250MHz

to 700MHz. The VCO frequency is programmed in steps equal to the value of the crystal frequency divided by 16. The VCO and output frequency can be programmed using the serial or parallel interfaces to the configuration logic. The output can be configured to divide the VCO frequency by 1, 2, 4, and 8. Output frequency steps as small as 125kHz to 1MHz can be achieved using a 16MHz crystal depending on the output dividers.

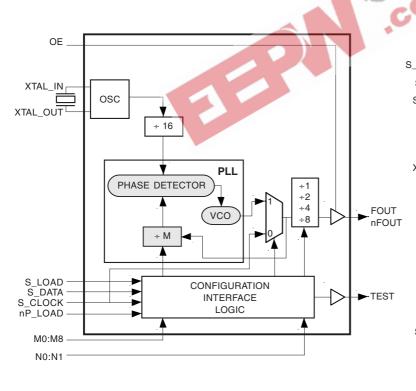
FEATURES

- Fully integrated PLL, no external loop filter requirements
- One differential 3.3V LVPECL output
- Parallel resonant crystal oscillator interface
- Output frequency range: 31.25MHz to 700MHz
- VCO range: 250MHz to 700MHz
- Parallel interface for programming counter and output dividers during power-up
- · Serial 3 wire interface
- RMS Period jitter: 5.5ps (maximum)
- Cycle-to-cycle jitter: 35ps (maximuml)
- 3.3V supply voltage

PIN ASSIGNMENT

- 0°C to 70°C ambient operating temperature
- Available in both standard and lead-free RoHS compliant packages 📉

BLOCK DIAGRAM



\Box 25 24 23 22 21 20 19 S_CLOCK 26 18 □ N1 S_DATA 17 D NO 27 S_LOAD ICS84329B M8 28-Lead PLCC □ M7 Vcca 🗆 15 V Package nc M6 14 11.6mm x 11.4mm x 4.1mm nc 🗆 Top View XTAL_IN □ 12 M4 8 9 10 11

OE

LOAD

Vcc YEE

M2 M3

XTAL_OUT 30 29 28 27 S_CLOCK [S_DATA □ N1 ICS84329B 22 N0 S_LOAD [32-Lead LQFP 21 VCCA Y package 20 VCCA [□ м7 7mm x 7mm x 1.4mm nc Γ 6 19 Ы м6 Top View 18 M5 nc Γ 10 11 12 13 14 15 16 XTAL IN □ П M2 M0 nP_

LOAD

TUO

700MHz, Low Jitter, Crystal-to-3.3V Differential LVPECL Frequency Synthesizer

FUNCTIONAL DESCRIPTION

NOTE: The functional description that follows describes operation using a 16MHz crystal. Valid PLL loop divider values for different crystal or input frequencies are defined in the Input Frequency Characteristics, Table 6, NOTE 1.

The ICS84329B features a fully integrated PLL and therefore requires no external components for setting the loop bandwidth. A series-resonant, fundamental crystal is used as the input to the on-chip oscillator. The output of the oscillator is divided by 16 prior to the phase detector. With a 16MHz crystal this provides a 1MHz reference frequency. The VCO of the PLL operates over a range of 250MHz to 700MHz. The output of the M divider is also applied to the phase detector.

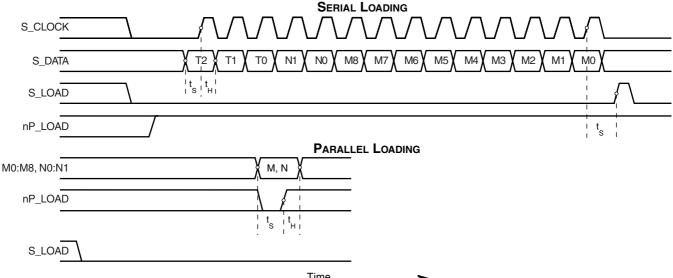
The phase detector and the M divider force the VCO output frequency to be M times the reference frequency by adjusting the VCO control voltage. Note that for some values of M (either too high or too low), the PLL will not achieve lock. The output of the VCO is scaled by a divider prior to being sent to each of the LVPECL output buffers. The divider provides a 50% output duty cycle.

The programmable features of the ICS84329B support two input modes to program the M divider and N output divider. The two input operational modes are parallel and serial. *Figure 1* shows the timing diagram for each mode. In parallel mode the nP_LOAD input is LOW. The data on inputs M0 through M8 and N0 through N1 is passed directly to the M divider and

The M value and the required values of M0 through M8 are shown in Table 3B, Programmable VCO Frequency Function Table. Valid M values for which the PLL will achieve lock are defined as $250 \le M \le 511$. The frequency out is defined as follows: fout $= \frac{fVCO}{N} = \frac{fxtal}{16} \times \frac{M}{N}$

Serial operation occurs when nP_LOAD is HIGH and S_LOAD is LOW. The shift register is loaded by sampling the S_DATA bits with the rising edge of S_CLOCK. The contents of the shift register are loaded into the M divider when S_LOAD transitions from LOW-to-HIGH. The M divide and N output divide values are latched on the HIGH-to-LOW transition of S_LOAD. If S_LOAD is held HIGH, data at the S_DATA input is passed directly to the M divider on each rising edge of S_CLOCK. The serial mode can be used to program the M and N bits and test bits T2:T0. The internal registers T2:T0 determine the state of the TEST output as follows:

T2	T1	T0	TEST Output	fOUT
0	0	0	Shift Register Out	fOUT
0	0	1	High	fOUT
0	1	0	PLL Reference Xtal ÷ 16	fOUT
0	1	1	VCO ÷ M (non 50% Duty M divider)	fOUT
1	0	0	fOUT LVCMOS Output Frequency < 200MHz	fOUT
1	0	1	Low	fOUT
1	1	0	S_CLOCK ÷ M (non 50% Duty Cycle M divider)	S_CLOCK ÷ N divider
1	1	1	fOUT ÷ 4	fOUT





700MHz, Low Jitter, Crystal-to-3.3V Differential LVPECL Frequency Synthesizer

TABLE 1. PIN DESCRIPTIONS

Name	Ty	/ре	Description			
V _{CCA}	Power		Analog supply pin.			
XTAL_IN, XTAL_OUT	Input		Crystal oscillator interface. XTAL_IN is the input. XTAL_OUT is the output.			
OE	Input	Pullup	Output enable. When logic HIGH, the outputs are enabled (default). When logic LOW, the outputs are disabled and drive differential low: FOUT = LOW, nFOUT = HIGH. LVCMOS / LVTTL interface levels.			
nP_LOAD	Input	Pullup	Parallel load input. Determines when data present at M8:M0 is loaded into M divider, and when data present at N1:N0 sets the N output divide value. LVCMOS / LVTTL interface levels.			
M0, M1, M2, M3, M4, M5, M6, M7, M8	Input	Pullup	M divider inputs. Data latched on LOW-to-HIGH transistion of nP_LOAD input. LVCMOS / LVTTL interface levels.			
N0, N1	Input	Pullup	Determines N output divider value as defined in Table 3C Function Table. LVCMOS / LVTTL interface levels.			
V _{EE}	Power		Negative supply pins.			
TEST	Output		Test output which is used in the serial mode of operation. LVCMOS / LVTTL interface levels.			
V _{cc}	Power		Core supply pins.			
nFOUT, FOUT	Output		Differential output for the synthesizer. 3.3V LVPECL interface levels.			
S_CLOCK	Input	Pulldown	Clocks the serial data present at S_DATA input into the shift register on the rising edge of S_CLOCK. LVCMOS / LVTTL interface levels.			
S_DATA	Input	Pulldown	Shift register serial input. Data sampled on the rising edge of S_CLOCK. LVCMOS / LVTTL interface levels.			
S_LOAD	Input	Pulldown	Controls transition of data from shift register into the M divider. LVCMOS / LVTTL interface levels.			

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ

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TABLE 3A. PARALLEL AND SERIAL MODE FUNCTION TABLE

			Inputs			Canditions					
nP_LOAD	M	N	S_LOAD	S_CLOCK	S_DATA	Conditions					
X	Х	Х	Х	Х	Χ	Reset. M and N bits are all set HIGH.					
L	Data	Data	Х	Х	Х	Data on M and N inputs passed directly to M divider N output divider. TEST mode 000.					
1	Data	Data	L	X	Х	Data is latched into input registers and remains loade until next LOW transition or until a serial event occurs					
Н	Х	Х	L	↑	Data	Serial input mode. Shift register is loaded with data on S_DATA on each rising edge of S_CLOCK.					
Н	Х	Х	↑	L	Data	Contents of the shift register are passed to the M divider and N output divider.					
Н	X	Х	\downarrow	L	Data	M divide and N output divide values are latched.					
Н	Х	Х	L	Х	Х	Parallel or serial input do not affect shift registers.					
H = X = ↑ = ↓= F	H X X L X X Parallel or serial input do not affect shift registers. NOTE: L = LOW H = HIGH X = Don't care ↑ = Rising edge transition ↓ = Falling edge transition										
TABLE 3B. F	ROGRAN	IMABLE	VCO FREQU	JENCY FUNCTI	ON TABLE						

TABLE 3B. PROGRAMMABLE VCO FREQUENCY FUNCTION TABLE

VCO Frequency	M Divide	256	128	64	32	16	8	4	2	1
(MHz)	W DIVIGE	M8	M7	M6	M5	M4	М3	M2	M1	МО
250	250	0	1	1	1	1	1	0	1	0
251	251	0	1	1	1	1	1	0	1	1
252	252	0	1	1	1	1	1	1	0	0
253	253	0	1	1	1	1	1	1	0	1
•	•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•	•
509	509	1	1	1	1	1	1	1	0	1
510	510	1	1	1	1	1	1	1	1	0
511	511	1	1	1	1	1	1	1	1	1

NOTE 1: These M divide values and the resulting frequencies correspond to a crystal frequency of 16MHz.

TABLE 3C. PROGRAMMABLE OUTPUT DIVIDER FUNCTION TABLE

Inp	outs	N Divider Value	Output Frequency (MHz)		
N1	N0	N Divider value	Minimum	Maximum	
0	0	1	250	700	
0	1	2	125	350	
1	0	4	62.5	175	
1	1	8	31.25	87.5	



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ABSOLUTE MAXIMUM RATINGS

4.6V Supply Voltage, V_{CC}

-0.5V to $V_{CC} + 0.5V$ Inputs, V

 $\begin{array}{c} \text{Outputs, I}_{\text{O}} \\ \text{Continuous Current} \end{array}$ 50mA Surge Current 100mA

Package Thermal Impedance, θ_{JA} 37.8°C/W (0 lfpm)

-65°C to 150°C Storage Temperature, T_{STG}

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the DC Characteristics or AC Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, Ta = 0°C to 70°C

Symbol	Parameter	Test Condi	tions	Minimum	Typical	Maximum	Units
V _{cc}	Core Supply Voltage		4 13	3.135	3.3	3.465	V
V _{CCA}	Analog Supply Voltage		16 m	3.135	3.3	3.465	V
I _{cc}	Power Supply Current		"O"			125	mA
I _{CCA}	Analog Supply Current		1.0			15	mA

Table 4B. LVCMOS / LVTTL DC Characteristics, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, Ta = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage			2		V _{cc} + 0.3	V
V _{IL}	Input Low Voltage			-0.3		0.8	V
	Input High Current	M0-M8, N0, N1, OE, nP_LOAD	$V_{CC} = V_{IN} = 3.465V$			5	μΑ
Input High Current	S_LOAD, S_DATA, S_CLOCK	$V_{CC} = V_{IN} = 3.465V$			150	μΑ	
	Input Low Current	M0-M8, N0, N1, OE, nP_LOAD	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			μΑ
' _{IL}		S_LOAD, S_DATA, S_CLOCK	$V_{CC} = 3.465V, V_{IN} = 0V$	-5			μΑ
V _{OH}	Output High Voltage; NOTE 1			2.6			V
V _{OL}	Output Low Voltage	; NOTE 1				0.5	V

NOTE 1: Outputs terminated with 50Ω to $V_{cc}/2$. See Parameter Measurement Information, 3.3V Output Load Test Circuit.

Table 4C. LVPECL DC Characteristics, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, Ta = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		V _{cc} - 1.4		V _{cc} - 0.9	V
V _{OL}	Output Low Voltage; NOTE 1		V _{cc} - 2.0		V _{cc} - 1.7	V
V _{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE 1: Outputs terminated with 50 $\!\Omega$ to V $_{\!\scriptscriptstyle CC}$ - 2V.

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TABLE 5. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fı	ındamenta	al	
Frequency		10		25	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

Table 6. Input Frequency Characteristics, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, Ta = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f.	Input Fraguanay	XTAL; NOTE 1		10		25	MHz
T _{IN}	Input Frequency	S_CLOCK		40.10		50	MHz

NOTE 1: For the crystal frequency range the M value must be set to achieve the minimum or maximum VCO frequency range of 250MHz or 700MHz. Using the minimum frequency of 10MHz valid values of M are $400 \le M \le 511$. Using the maximum frequency of 25MHz valid values of M are $160 \le M \le 448$.

Table 7. AC Characteristics, $V_{CC} = V_{CGA} = 3.3V \pm 5\%$, Ta = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
F _{out}	Output Frequency				700	MHz
fiit(nor)	Period Jitter, RMS; NOTE 1, 2	fOUT ≥ 65MHz			5.5	ps
tjit(per)	Feriod Sitter, NIVIS, NOTE 1, 2	fOUT < 65MHz			12	ps
fiit(cc)	Cycle to Cycle litter NOTE 1 2	fOUT ≥ 50MHz			35	ps
tjit(cc)	Cycle-to-Cycle Jitter; NOTE 1, 2	fOUT < 50MHz			50	ps
t_R/t_F	Output Rise/Fall Time	20% to 80%	300		800	ps
t _s	Setup Time		5			ns
t _H	Hold Time		5			ns
t_	PLL Lock Time				10	ms
odc	Output Duty Cycle		45	50	55	%

See Parameter Measurement Information section.

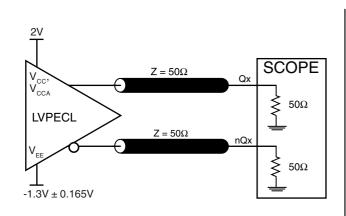
Characterized using a 16MHz XTAL.

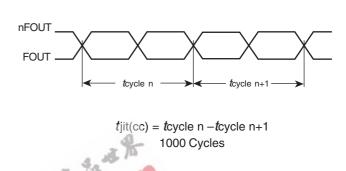
NOTE 1: This parameter is defined in accordance with JEDEC Standard 65

NOTE 2: See Applications section.

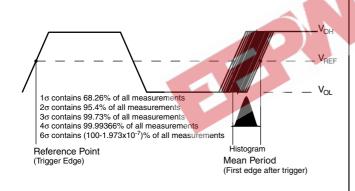
700MHz, Low Jitter, Crystal-to-3.3V Differential LVPECL Frequency Synthesizer

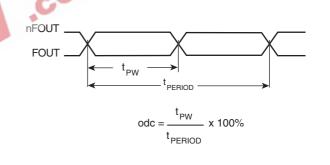
PARAMETER MEASUREMENT INFORMATION





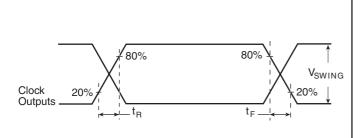
3.3V OUTPUT LOAD AC TEST CIRCUIT





OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

PERIOD JITTER



S_DATA S_CLOCK t_{SET-UF} S LOAD ItseT-UP M0:M8 N0:N1 nP_LOAD t_{HOLD} It_{SET-UP}I

OUTPUT RISE/FALL TIME

DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

APPLICATION INFORMATION

Power Supply Filtering Techniques

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS84329B provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. $V_{\rm cc}$ and $V_{\rm ccA}$ should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. Figure 2 illustrates how a 10Ω resistor along with a $10\mu F$ and a $.01\mu F$ bypass capacitor should be connected to each $V_{\text{\tiny CCA}}$ pin. The 10Ω resistor can also be replaced by a ferrite bead.

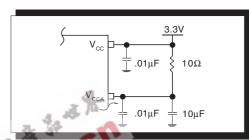
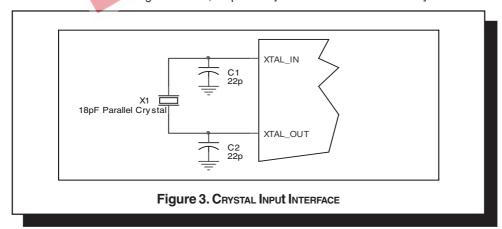


FIGURE 2. POWER SUPPLY FILTERING

CRYSTAL INPUT INTERFACE

The ICS84329B has been characterized with 18pF parallel resonant crystals. The capacitor values, C1 and C2, shown in Figure 3 below were determined using a 25MHz, 18pF parallel resonant crystal and were chosen to minimize the ppm error. The optimum C1 and C2 values can be slightly adjusted for different board layouts.



RECOMMENDATIONS FOR UNUSED INPUT PINS

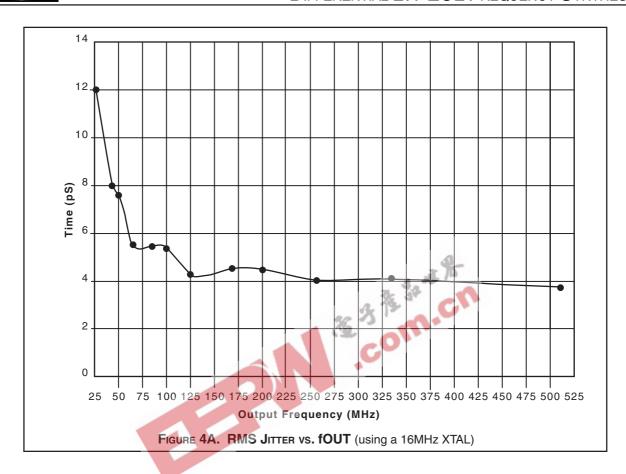
INPUTS:

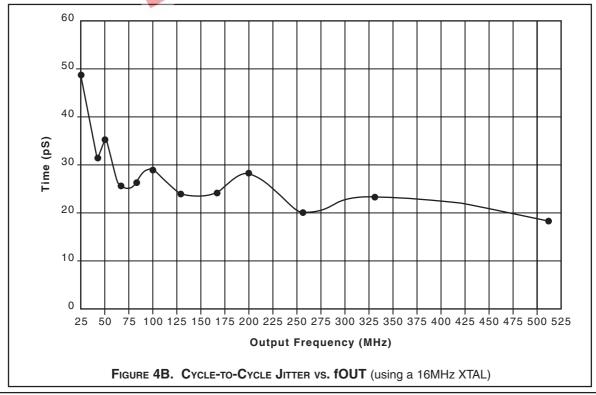
LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A $1k\Omega$ resistor can be used.



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LAYOUT GUIDELINE

The schematic of the ICS84329B layout example used in this layout guideline is shown in *Figure 5A*. The ICS84329B recommended PCB board layout for this example is shown in *Figure 5B*. This layout example is used as a general guideline. The

layout in the actual system will depend on the selected component types, the density of the components, the density of the traces, and the stack up of the P.C. board.

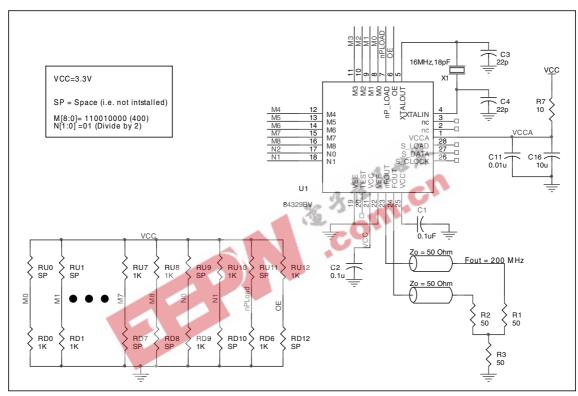


FIGURE 5A. SCHEMATIC OF RECOMMENDED LAYOUT FOR 28 LEAD PLCC



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The following component footprints are used in this layout example:

All the resistors and capacitors are size 0603.

POWER AND GROUNDING

Place the decoupling capacitors C1, C2 and C3, as close as possible to the power pins. If space allows, placement of the decoupling capacitor on the component side is preferred. This can reduce unwanted inductance between the decoupling capacitor and the power pin caused by the via.

Maximize the power and ground pad sizes and number of vias capacitors. This can reduce the inductance between the power and ground planes and the component power and ground pins.

The RC filter consisting of R7, C11, and C16 should be placed as close to the $V_{\rm CGA}$ pin as possible.

CLOCK TRACES AND TERMINATION

Poor signal integrity can degrade the system performance or cause system failure. In synchronous high-speed digital systems, the clock signal is less tolerant to poor signal integrity than other signals. Any ringing on the rising or falling edge or excessive ring back can cause system failure. The shape of the trace and the trace delay might be restricted by the available space on the board and the component location. While routing the traces, the clock signal traces should be routed first and should be locked prior to routing other signal traces.

- The differential 50Ω output traces should have the same length.
- Avoid sharp angles on the clock trace. Sharp angle turns cause the characteristic impedance to change on the transmission lines.
- Keep the clock traces on the same layer. Whenever possible, avoid placing vias on the clock traces. Placement of vias on the traces can affect the trace characteristic impedance and hence degrade signal integrity.
- To prevent cross talk, avoid routing other signal traces in parallel with the clock traces. If running parallel traces is unavoidable, allow a separation of at least three trace widths between the differential clock trace and the other signal trace.
- Make sure no other signal traces are routed between the clock trace pair.
- The matching termination resistors should be located as close to the receiver input pins as possible.

CRYSTAL

The crystal X1 should be located as close as possible to the pins 4 (XTAL_IN) and 5 (XTAL_OUT). The trace length between the X1 and U1 should be kept to a minimum to avoid unwanted parasitic inductance and capacitance. Other signal traces should not be routed near the crystal traces.

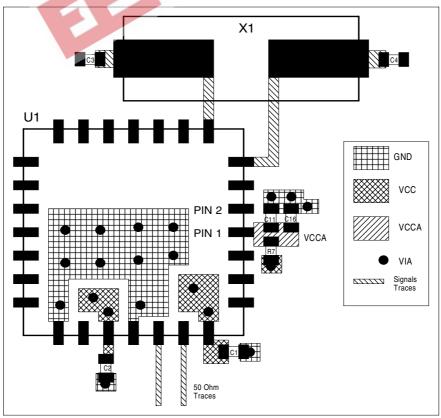


FIGURE 5B. PCB BOARD LAYOUT FOR ICS84329B 28 LEAD PLCC

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TERMINATION FOR LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are

designed to drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minmize signal distortion. Figures 6A and 6B show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

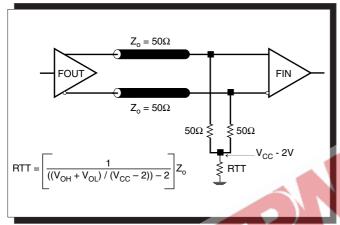


FIGURE 6A. LVPECL OUTPUT TERMINATION

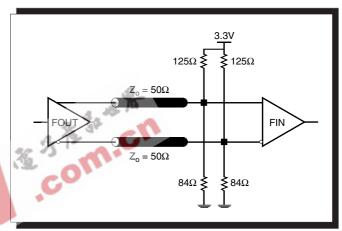


FIGURE 6B. LVPECL OUTPUT TERMINATION

700MHz, Low Jitter, Crystal-to-3.3V Differential LVPECL Frequency Synthesizer

Power Considerations

This section provides information on power dissipation and junction temperature for the ICS84329B. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS84329B is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{CC} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{CC_MAX} * I_{EE_MAX} = 3.465V * 140mA = 485mW
- Power (outputs)_{MAX} = 30mW/Loaded Output pair

Total Power MAX (3.465V, with all outputs switching) = 485mW + 30mW = 515mW

2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS TM devices is 125°C.

The equation for Tj is as follows: $Tj = \theta_{JA} * Pd_total + T_A$

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

 $T_A = Ambient Temperature$

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 31.1°C/W per Table 8A below.

Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:

 $70^{\circ}\text{C} + 0.515\text{W} * 31.1^{\circ}\text{C/W} = 86^{\circ}\text{C}$. This is well below the limit of 125°C .

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

Table 8A. Thermal Resistance θ_{IA} for 28-pin PLCC, Forced Convection

θ_{JA} by Velocity (Linear Feet per Minute) 0 200 500 Multi-Layer PCB, JEDEC Standard Test Boards 37.8°C/W 31.1°C/W 28.3°C/W NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

Table 8B. Thermal Resistance $\theta_{,ia}$ for 32-pin LQFP, Forced Convection

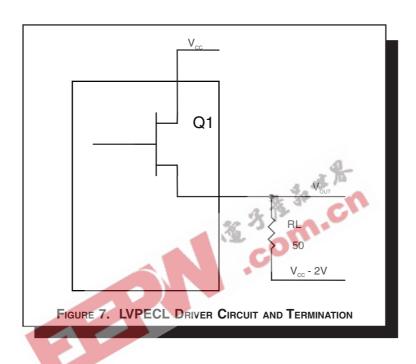
θ _a by Velocity (Linear Feet per Minute)				
	0	200	500	
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W	
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W	
NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.				

700MHz, Low Jitter, Crystal-to-3.3V Differential LVPECL Frequency Synthesizer

3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in the Figure 7.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{cc} - 2V.

• For logic high,
$$V_{OUT} = V_{OH_MAX} = V_{CC_MAX} - 0.9V$$

$$(V_{CC MAX} - V_{OH MAX}) = 0.9V$$

• For logic low,
$$V_{OUT} = V_{OL_MAX} = V_{CC_MAX} - 1.7V$$

$$(V_{CC_MAX} - V_{OL_MAX}) = 1.7V$$

Pd_H is power dissipation when the output drives high. Pd_L is the power dissipation when the output drives low.

$$Pd_H = [(V_{OH_MAX} - (V_{CC_MAX} - 2V))/R_{L}] * (V_{CC_MAX} - V_{OH_MAX}) = [(2V - (V_{CC_MAX} - V_{OH_MAX}))/R_{L}] * (V_{CC_MAX} - V_{OH_MAX}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd_{L} = [(V_{OL_MAX} - (V_{CC_MAX} - 2V))/R_{L}] * (V_{CC_MAX} - V_{OL_MAX}) = [(2V - (V_{CC_MAX} - V_{OL_MAX}))/R_{L}] * (V_{CC_MAX} - V_{OL_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair = Pd_H + Pd_L = 30mW



RELIABILITY INFORMATION

Table 9A. $\theta_{\text{JA}} \text{vs. Air Flow Table for 28 Lead PLCC}$

θ_{...} by Velocity (Linear Feet per Minute)

200 500

Multi-Layer PCB, JEDEC Standard Test Boards 37.8°C/W 28.3°C/W 31_1°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TABLE 9B. θ_{1A} VS. AIR FLOW TABLE FOR 32 LEAD LQFP

θ_{ιδ} by Velocity (Linear Feet per Minute)

0 200 500 Single-Layer PCB, JEDEC Standard Test Boards 67.8°C/W 55.9°C/W 50.1°C/W Multi-Layer PCB, JEDEC Standard Test Boards 47.9°C/W 42.1°C/W 39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS84329B is: 4408

Pin compatible with the MC12429



PACKAGE OUTLINE - V SUFFIX FOR 28 LEAD PLCC

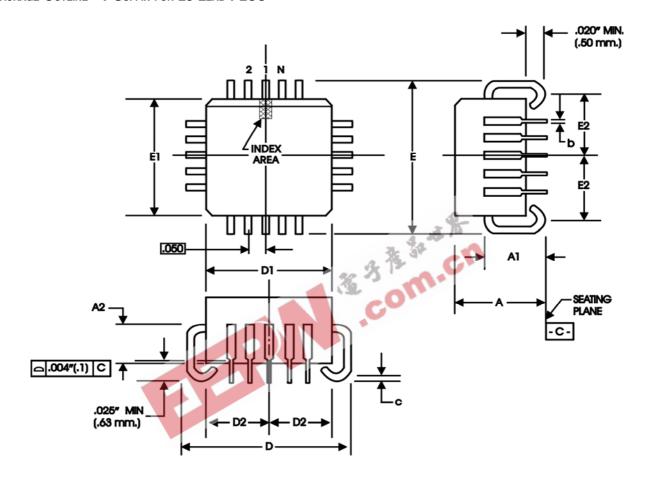


TABLE 10A. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS			
SYMBOL	MINIMUM	MAXIMUM	
N	28		
Α	4.19	4.57	
A1	2.29	3.05	
A2	1.57	2.11	
b	0.33	0.53	
С	0.19	0.32	
D	12.32	12.57	
D1	11.43	11.58	
D2	4.85	5.56	
E	12.32	12.57	
E1	11.43	11.58	
E2	4.85	5.56	

Reference Document: JEDEC Publication 95, MS-018



PACKAGE OUTLINE - Y SUFFIX 32 LEAD LQFP

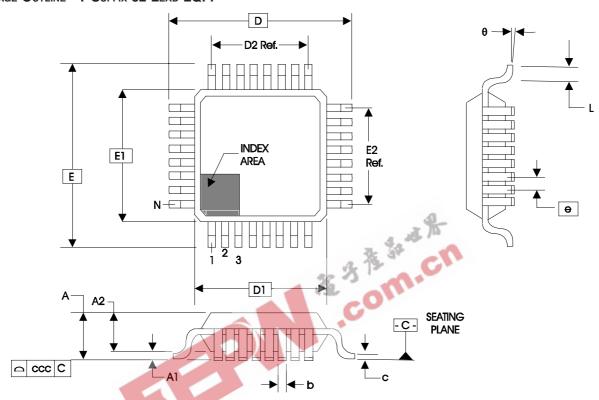


TABLE 10B. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS				
0.44501	ВВА			
SYMBOL	MINIMUM	NOMINAL	MAXIMUM	
N	32			
Α			1.60	
A1	0.05		0.15	
A2	1.35	1.40	1.45	
b	0.30	0.37	0.45	
С	0.09		0.20	
D	9.00 BASIC			
D1	7.00 BASIC			
D2	5.60 Ref.			
E	9.00 BASIC			
E1	7.00 BASIC			
E2	5.60 Ref.			
е	0.80 BASIC			
L	0.45	0.60 0.75		
θ	0°	7°		
ccc			0.10	

Reference Document: JEDEC Publication 95, MS-026



700MHz, Low Jitter, Crystal-to-3.3V DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

Table 11. Ordering Information

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS84329BV	ICS84329BV	28 Lead PLCC	Tube	0°C to 70°C
ICS84329BVT	ICS84329BV	28 Lead PLCC	500 Tape & Reel	0°C to 70°C
ICS84329BVLF	ICS84329BVLF	28 Lead "Lead-Free" PLCC	Tube	0°C to 70°C
ICS84329BVLFT	ICS84329BVLF	28 Lead "Lead-Free" PLCC	500 Tape & Reel	0°C to 70°C
ICS84329BY	ICS84329BY	32 Lead LQFP	Tray	0°C to 70°C
ICS84329BYT	ICS84329BY	32 Lead LQFP	1000 Tape & Reel	0°C to 70°C
ICS84329BYLF	ICS84329BYLF	32 Lead "Lead-Free" LQFP	Tray	0°C to 70°C
ICS84329BYLFT	ICS84329BYLF	32 Lead "Lead-Free" LQFP	1000 Tape & Reel	0°C to 70°C

NOTE: Parts thar are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.



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700MHz, Low Jitter, Crystal-to-3.3V Differential LVPECL Frequency Synthesizer

REVISION HISTORY SHEET				
Rev	Table	Page	age Description of Change	
Α		1	Features Section - added "Parallel resonant" to crystal bullet.	12/15/04
		1	Features Section - corrected Output frequency range from 25MHz to 31.25MHz. Added Lead-Free bullet.	
В		2	Updated Parallel & Serial Load Operations.	6/10/05
	T5	6	Crystal Table - added Drive Level.	
	T11	17	Ordering Information Table - added Lead-Free part numbers and note.	
		8	Power Supply Filtering Techniques - added ferrite bead sentence.	
В		8	Added Recommendations for Unused Input and Output Pins.	1/18/06
	T11	18	Ordering Information Table - added Lead-Free marking.	

